SN54ABT16373, SN74ABT16373 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCBS469 - FEBRUARY 1991 - REVISED OCTOBER 1992

 Members of the Texas Instruments Widebus[™] Family State-of-the-Art EPIC-IIB[™] BiCMOS Design 	SN54ABT16373 WD PACKAGE SN74ABT16373 DL PACKAGE (TOP VIEW)
Significantly Reduces Power Dissipation	
 ESD Protection Exceeds 2000 V Per 	
MIL-STD-883C, Method 3015; Exceeds	1Q2 3 46 1D2
200 V Using Machine Model (C = 200 pF,	
R = 0)	1Q3 5 44 1D3
Latch-Up Performance Exceeds 500 mA	1Q4 [6 43] 1D4
Per JEDEC Standard JESD-17	V _{CC} []7 42] V _{CC}
 Typical V_{OLP} (Output Ground Bounce) 	1Q5 🛛 8 41 🗋 1D5
< 0.8 V at V _{CC} = 5 V, T _A = 25°C	1Q6 g 40 l 1D6
 Distributed V_{CC} and GND Pin Configuration 	GND 10 39 GND
Minimizes High-Speed Switching Noise	
• Flow-Through Architecture Optimizes	
PCB Layout	
 High-Drive Outputs (-32-mA I_{OH}, 	2Q2 4 14 35 2D2 GND 15 34 GND
64-mA I _{OL})	2Q3 16 33 2D3
Packaged in Plastic 300-mil Shrink	GND 115 34 GND 2Q3 16 33 2D3 2Q4 17 32 2D4 V _{CC} 18 31 V _{CC} 2Q5 19 30 2D5 2Q6 20 29 2D6 GND 21 28 GND
Small-Outline Packages and 380-mil	
Fine-Pitch Ceramic Flat Packages Using 🚄 🔏	2Q5 [19 30] 2D5
25-mil Center-to-Center Spacings	2Q6 20 29 2D6
	GND 21 28 GND
description	2Q7 22 27 207
The 4ABT16373 is a 16-bit transparent D-type	2Q8 🛛 23 26 🗋 2D8
latch with 3-state outputs designed specifically for	2 0E [24 25] 2LE
driving highly capacitive or relatively	

The device can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components

The output enable (\overline{OE}) does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16373 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16373 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ABT16373 is characterized for operation from -40° C to 85° C.

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low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.



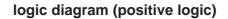
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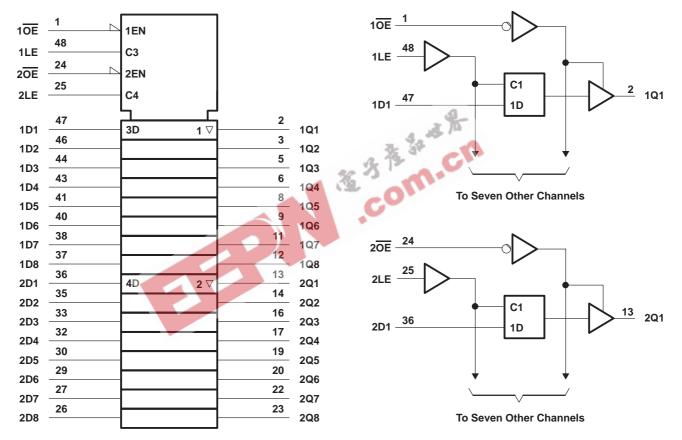
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SCBS469 - FEBRUARY 1991 - REVISED OCTOBER 1992

FUNCTION TABLE (each latch)							
	OUTPUT						
OE	LE	D	Q				
L	Н	Н	Н				
L	Н	L	L				
L	L	Х	Q ₀				
Н	Х	Х	z				

logic symbol[†]





[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1)	
Voltage range applied to any output in the high state or power-off state, Vo	
Current into any output in the low state, I _O : SN54ABT16373	96 mA
SN74ABT16373	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air)	0.85 W
Storage temperature range	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 2)

		SN54ABT16373	SN74ABT16373	UNIT
		MIN MAX	MIN MAX	UNIT
VCC	Supply voltage	4.5 5.5	4.5 5.5	V
VIH	High-level input voltage	2	2	V
VIL	Low-level input voltage	0.8	0.8	V
VI	Input voltage	0 VCC	0 V _{CC}	V
ЮН	High-level output current	0 -24	-32	mA
IOL	Low-level output current	A 48	64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate Outputs enabled	5 10	10	ns/V
TA	Operating free-air temperature	-55 125	-40 85	°C

NOTE 2: Unused or floating inputs must be held high or low.

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SN54ABT16373, SN74ABT16373 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS SCB5469 - FEBRUARY 1991 - REVISED OCTOBER 1992

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS			T _A = 25°C			3T16373	SN74ABT16373		
PARAMETER				TYP [†]	MAX	MIN	MAX	MIN	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V}, I_{I} = -18 \text{ mA}$			-1.2		-1.2		-1.2	V	
	$V_{CC} = 4.5 \text{ V}, I_{OH} = -3 \text{ mA}$		2.5			2.5		2.5		
\/	$V_{CC} = 5 V$, $I_{OH} = -3 mA$		3			3		3		V
VOH	$V_{CC} = 4.5 \text{ V}, I_{OH} = -24 \text{ m/s}$	ł	2			2				V
	$V_{CC} = 4.5 \text{ V}, I_{OH} = -32 \text{ m}.$	٩	2‡					2		
Ve	$V_{CC} = 4.5 \text{ V}, I_{OL} = 48 \text{ mA}$				0.55		0.55			V
VOL	$V_{CC} = 4.5 \text{ V}, I_{OL} = 64 \text{ mA}$				0.55‡				0.55	v
Ц	$V_{CC} = 5.5 \text{ V}, V_{I} = V_{CC} \text{ or GND}$				±1		E		±1	μΑ
IOZH	$V_{CC} = 5.5 \text{ V}, V_{O} = 2.7 \text{ V}$				50		50		50	μΑ
IOZL	$V_{CC} = 5.5 \text{ V}, V_{O} = 0.5 \text{ V}$				-50	4	2 – 50		-50	μΑ
l _{off}	$V_{CC} = 0,$ $V_I \text{ or } V_O \le 4.5$	5 V			±100	(C)	,		±100	μΑ
ICEX	$V_{CC} = 5.5 \text{ V}, V_O = 5.5 \text{ V}$	Outputs high			50	20	50		50	μΑ
۱ _O §	$V_{CC} = 5.5 \text{ V}, V_O = 2.5 \text{ V}$		-50	-100	-180	-50	-180	-50	-180	mA
		Outputs high		25.0	2		2		2	
ICC	$V_{CC} = 5.5 \text{ V}, I_O = 0,$ $V_I = V_{CC} \text{ or GND}$	Outputs low		23	85		85		85	mA
		Outputs disabled	X	2.	2		2		2	
∆ICC∥	$V_{CC} = 5.5 \text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND			co	1.5		1.5		1.5	mA
Ci	VI = 2.5 V or 0.5 V		3.5						pF	
Co	V _O = 2.5 V or 0.5 V			9.5						pF

[†] All typical values are at $V_{CC} = 5 V$.

[‡]On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		V _{CC} = 5 V, T _A = 25°C		SN54ABT16373 SN74ABT16373		UNIT	
		MIN	MAX		MIN	MAX	
tw	Pulse duration, LE high	3.3		3.3	3.3		ns
t _{su}	Setup time, data before LE \downarrow	1.5		1.5	1.5		ns
th	Hold time, data after LE \downarrow	1		R R	1		ns

SN54ABT16373, SN74ABT16373 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS SCBS469 - FEBRUARY 1991 - REVISED OCTOBER 1992

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	V(T/	CC = 5 V A = 25°C	, ,	SN54AB	T16373	SN74AB	T16373	UNIT
	(INPUT)	(001P01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	D	Q	1.9	4.1	5.3	1.9	6.5	1.9	6.3	ns
^t PHL	D	ý	2.3	4.3	5.4	2.3	6.5	2.3	6.2	115
^t PLH	LE	Q	2.1	4.5	5.7	2.1	J 7	2.1	6.7	
^t PHL	LE	Q	2.6	4.5	5.6	2.6	6.3	2.6	6.1	ns
^t PZH	ŌĒ	Q	1.5	3.9	5	1.5	6.4	1.5	6.1	
^t PZL	UE	Q	1.8	3.8	4.9	1.8	5.8	1.8	5.6	ns
^t PHZ	ŌĒ	Q	2.4	6.5	8.8	2.4	10.8	2.4	10.3	
^t PLZ	UL UL	Ŷ,	2.3	5.3	7.6	2.3	8.7	2.3	8.1	ns

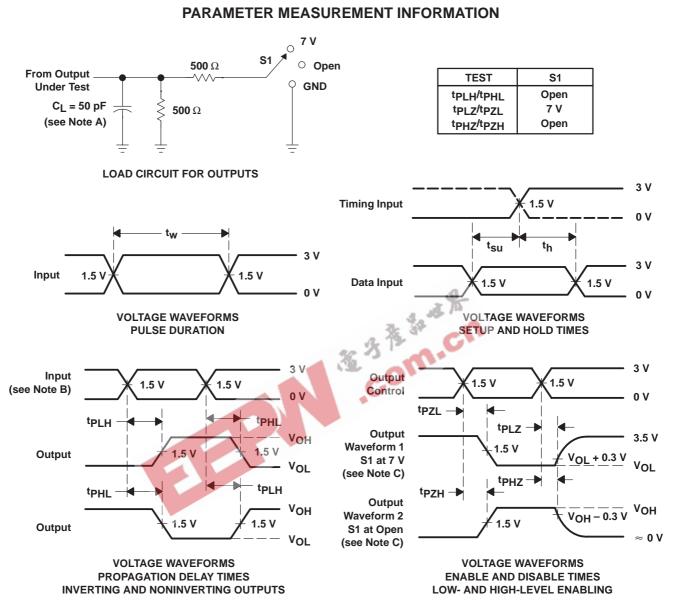


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SCBS469 - FEBRUARY 1991 - REVISED OCTOBER 1992



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 - Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



24-Jun-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ABT16373DGGR	OBSOLETE	TSSOP	DGG	48	TBD	Call TI	Call TI
SN74ABT16373DL	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI
SN74ABT16373DLR	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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